



SKP19-T6CL SKP13-T6CL

COM EXPRESS TYPE 6 + GPU EMBEDDED
SYSTEM



- High-End CPUs with latest generation x86 processors in a ruggedized small form factor
- Up To 6 Display port
- 2 x VGA, 1 x LVDS, 4 x COM, 6 x USB, 2 x mini PCIe, 1 x M.2, 2 x SATA
- 9-36V DC-IN

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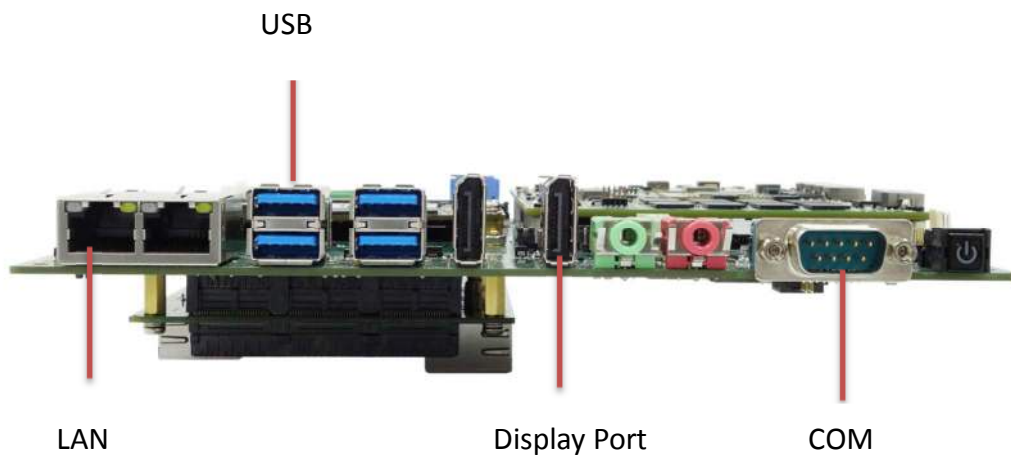
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Instructions

COM Express, a computer-on-module (COM) form factor, is a highly integrated and compact PC that can be used in a design application much like an integrated circuit component. The COM Express Module integrates core CPU and memory functionality, the common I/O of a PC/AT, USB, audio, graphics (PEG), and Ethernet.

SK513 feature a range of Intel processors, up to the latest Intel Core series. SK513 are built to operate in harsh environmental conditions, the operating temperatures as low as -40°C to as hot as 85°C. From low power consumption to high performance processing power, SK513 are built to suit a wide range of computing applications from signal processing to unmanned vehicles and more.



Key Features of SK513

(1) Efficiency product design

(2) Fast system integration

(3) Rich Expansion Slot



GPU Products List

| GPU | CUDA Cores |
|---------|---|
| Quadro | P3000 (1280 CUDA Cores, 75W) P5000 (2560 CUDA Cores, 100W) RTX3000 (1920 CUDA Cores, 80W) RTX5000 (3072 CUDA Cores, 110W) |
| GeForce | RTX2060 (2176 CUDA Cores, 175W) GTX1080 (XXX CUDA Cores, 180W) GTX1660S (1048 CUDA Cores, 95W) GTX1050Ti (768 CUDA Cores, 75W) |

Description of Key Features

(1)Efficiency product design

In order to design all kinds of products in the shortest time, the COM Express provide a better way to improvement the process. SK513 does not only provide the COM Express carrier board, but also MXM, PCIe, M.2 and mimi PCI slot, will make the preliminary verification work more efficient. The solutions include:

- Mimi PCIe Expansion: 2x full size mimi PCIe (1 with mSATA support)
- M.2 Expansion: 1x 2280 M key (SATA only)
- PCIe/104 Expansion: 4x PCI x1, 1x PCIe x4, 5 xUSB, 1 LPC, 1X SPI

(2) Fast system integration

SK513 is the fanless design for pass environment test, ex: IP65, MIL-STDG. No need to find the problem until the end, and confirm the design direction as soon as possible.

At the same time, SK513 use the mezzanine standard, mainly is used in industrial computers. Being mezzanines, they are always plugged on a carrier PCB that supports this format. The modules communicate with their carrier over a dedicated bus, and can have all kinds of special functions. All I/O signals are mapped to two high densities, low profile connectors on the bottom side of the module. COM Express employs a mezzanine-based approach. The COM modules plug into a baseboard that is typically customized to the application. Over time, the COM Express mezzanine modules can be upgraded to newer, backwards-compatible versions. COM Express is commonly used in Industrial, Military/Aerospace, Gaming, Medical, Transportation, IoT, and Computing embedded applications.

(3) Rich Expansion Slot

SK-513 provides rich expansion to make the whole solutions easier.

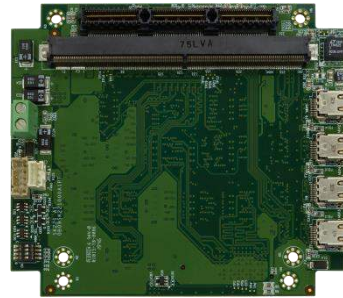
MXM

SK220



- PCIe/104 (Type 2) MXM-GPU Carrier
- Utilizes PCIe x16 and PCIe x4, x1 link
- 1VGA & 6 Mini DisplayPort
- MXM 3.0 and 3.1 graphic card support
- GTX1080, RTX2060S, Quadro RTX5000 support by separate DC-In
- Type A and Type B MXM graphic card and support
- Operating Temp: -40°C to 85°C

SK221



- PCIe/104 (Type 2) MXM- GPU Carrier
- Utilizes PCIe x16 and x4 Link
- 1 x VGA & 4 x Mini DisplayPort Module
- 12V DC Input
- MXM 3.0 and 3.1 Graphic Card support Type A and Type B MXM GPU
- Support up to NVIDIA GeForce GTX1080M (180W), Quadro RTX5000, RTX3000
- Operating Temp. -40°C to 85°C

NIC

SK506



- StackPC-FPE form factor
- PCIe/104 stackable bus structure
- Reliable Ethernet technology from Intel i350-AM4 controllers
- total 6 independent LAN connections (2 from host board, 4 from Intel controllers)
- Flexible options for Ethernets through RJ45 or 10 pin-headers
- High-performing bridgeless design supporting PCI Express Gen 2.1 5GT/s
- Extended temperature -40°C to 85°C

SK502



- Intel® X710-BM2 Controller
- 2 10GbE/1GbE SFP+ ports
- PCIe Gen.3 x4 host interface
- Rugged Stackable PCIe/104 form factors
- Supports 10GBASE-SR / 10GBASE-LR / 10GBASE-DAC / 10GBASE –GBIC module
- Supports SR-IOV based virtualization

COM

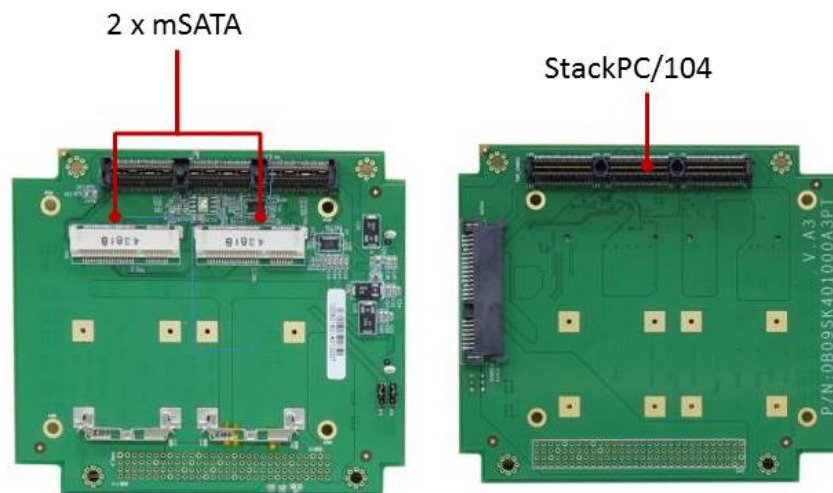
SK303



- **PCI/104-Express, PCI & PCIe connectors (w/StackPC design)**
- **PCIe/104 stackable bus structure**
- **PCIe to PCI adapter function**
- **COM: 4 x RS232/422/485 with 5V/12V selectable and isolation function**
- **Extended Temp.: -40°C to 85°C**

Storage

SK401



- **PCIe/104 stackable bus structure**
- **Supports 1 x 2.5" SSD, 2 x Mini PCIe slots**
- **Supports 2 x mSATA SSD slot, compatible with JEDEC MO-300B**
- **SATAII interface supports 1.5Gbps/3.0Gbps**
- **Reserve PCI/104 connector for different stacking criteria**
- **Extended temperature -40°C to 85°C**

Specifications

Processor & System

| | |
|---------------------------------|--|
| COM Express CPU Module (Type 6) | Intel® Xeon® E-2276ME (CoffeeLake 9th , 6 Cores/12 Threads, 12M Cache, up to 4.50 GHz), 45W Intel® Xeon® E-2276ML (CoffeeLake 9th , 6 Cores/12 Threads, 12M Cache, up to 4.20 GHz), 25W Intel® Core™ i7-9850HE (CoffeeLake 9th , 6 Cores/12 Threads, 9M Cache, up to 4.40 GHz), 45W Intel® Core™ i7-9850HL (CoffeeLake 9th , 6 Cores/12 Threads, 9M Cache, up to 4.10 GHz), 25W |
|---------------------------------|--|

GPU

| | |
|---------|---|
| Quadro | P3000 (1280 CUDA Cores, 75W) P5000 (2560 CUDA Cores, 100W) RTX3000 (1920 CUDA Cores, 80W) RTX5000 (3072 CUDA Cores, 110W) |
| GeForce | RTX2060 (2176 CUDA Cores, 175W) GTX1080 (XXX CUDA Cores, 180W) GTX1660S (1048 CUDA Cores, 95W) GTX1050Ti (768 CUDA Cores, 75W) |

Ethernet

| | |
|-----|---|
| LAN | Dual Gigabit (10/100/1000) Ports 1x Intel i210IT, 1 x from COM Express |
|-----|---|

Rear I/O

| | |
|-------------|--|
| USB | 4 x USB 3.0 |
| LAN | 2 x RJ45 |
| Serial Port | 1 x RS232/422/485 |
| Audio | 1 x 3.5mm Audio Jacks (1 x MIC-IN, 1 x LINE-OUT) |
| Display | 2 x DP |

Internal I/O

| | |
|----------------|-----------------------------------|
| MXM | 1 (Socket) |
| SATA Port | 2 (up to 6Gb/s)(Pin header) |
| SATA Power | 2 (Pin header) |
| MXM VGA | 1 (Pin header) |
| MXM DC IN | 1 (Pin header) |
| MXM DP | 2 (Pin header) |
| MB DC IN | 1 (Pin header) |
| LVDS | 1 (Pin header) |
| LVDS Backlight | 1 (Pin header) |
| COM | 3 (1X10Pin, 2.0Pitch)(Pin header) |

(RS232/422/485)

| | |
|-----------------|------------------------------|
| USB 2.0 | 2 (Pin header) |
| DIO | 8 Bit (4DI/4DO) (Pin header) |
| Battery Header | 1 (Pin header) |
| eSPI/LPC Header | 1 (Pin header) |

Expansion Slot

| | |
|----------|---|
| MXM | 1 (MXM3.1 Type B) |
| PCIe/104 | 1 |
| mPCIe | 2 x Full-size mini PCIe (USB+PCIe) ; 1 x with mSATA supported |
| SIM Slot | 1 |
| M.2 | 1x M.2 2280 M-Key Slot (SATA only) |

Power Management

| | |
|-------------|----------------|
| ACPI | ACPI 3.0 |
| Sleep State | S0, S1, S4, S5 |

Mechanical and Environmental

| | |
|-----------------------|---|
| Form Factor | Proprietary |
| Power Type | 9~36V DC IN(For System, 4P Terminal Block) ; 12V DC IN(For MXM, ATX 4P) |
| Dimension | 190 mm x 185 mm (Plan) |
| Operating Temperature | - 40°C ~ 85°C |
| Storage Temperature | - 40°C ~ 85°C |
| Relative humidity | 10% to 90%, non-condensing |

Accessories

| | |
|---------------|-------------------------|
| SINK+ FAN Kit | CPU(SINK)+MXM(SINK+FAN) |
|---------------|-------------------------|

Standard Compliance

| | |
|---------------------|--------|
| Standard Compliance | CE/FCC |
|---------------------|--------|

| Ordering Information | |
|----------------------|--|
| SK513-T605Q01 | CPU Board : i7-9850HL / MXM GPU : Quadro P3000 |
| SK513-T605Q02 | CPU Board : i7-9850HL / MXM GPU : Quadro P5000 |
| SK513-T605Q03 | CPU Board : i7-9850HL / MXM GPU : Quadro RTX3000 |
| SK513-T605Q04 | CPU Board : i7-9850HL / MXM GPU : Quadro RTX5000 |
| SK513-T605G01 | CPU Board : i7-9850HL / MXM GPU : RTX2060S |
| SK513-T605G02 | CPU Board : i7-9850HL / MXM GPU : GTX1080 |
| SK513-T605G03 | CPU Board : i7-9850HL / MXM GPU : GTX1660S |
| SK513-T605G04 | CPU Board : i7-9850HL / MXM GPU : GTX1050Ti |
| SK513-T606Q01 | CPU Board : i7-9850HE / MXM GPU : Quadro P3000 |
| SK513-T606Q02 | CPU Board : i7-9850HE / MXM GPU : Quadro P5000 |
| SK513-T606Q03 | CPU Board : i7-9850HE / MXM GPU : Quadro RTX3000 |
| SK513-T606Q04 | CPU Board : i7-9850HE / MXM GPU : Quadro RTX5000 |
| SK513-T606G01 | CPU Board : i7-9850HE / MXM GPU : RTX2060S |
| SK513-T606G02 | CPU Board : i7-9850HE / MXM GPU : GTX1080 |
| SK513-T606G03 | CPU Board : i7-9850HE / MXM GPU : GTX1660S |
| SK513-T606G04 | CPU Board : E3-1505L / MXM GPU : GTX1050Ti |
| SK513-T607Q01 | CPU Board : E-2276ML / MXM GPU : Quadro P3000 |
| SK513-T607Q02 | CPU Board : E-2276ML / MXM GPU : Quadro P5000 |
| SK513-T607Q03 | CPU Board : E-2276ML / MXM GPU : Quadro RTX3000 |
| SK513-T607Q04 | CPU Board : E-2276ML / MXM GPU : Quadro RTX5000 |
| SK513-T607G01 | CPU Board : E-2276ML / MXM GPU : RTX2060S |
| SK513-T607G02 | CPU Board : E-2276ML / MXM GPU : GTX1080 |
| SK513-T607G03 | CPU Board : E-2276ML / MXM GPU : GTX1660S |
| SK513-T607G04 | CPU Board : E-2276ML / MXM GPU : GTX1050Ti |
| SK513-T608Q01 | CPU Board : E-2276ME / MXM GPU : Quadro P3000 |
| SK513-T608Q02 | CPU Board : E-2276ME / MXM GPU : Quadro P5000 |
| SK513-T608Q03 | CPU Board : E-2276ME / MXM GPU : Quadro RTX3000 |
| SK513-T608Q04 | CPU Board : E-2276ME / MXM GPU : Quadro RTX5000 |
| SK513-T608G01 | CPU Board : E-2276ME / MXM GPU : RTX2060S |
| SK513-T608G02 | CPU Board : E-2276ME / MXM GPU : GTX1080 |
| SK513-T608G03 | CPU Board : E-2276ME / MXM GPU : GTX1660S |
| SK513-T608G04 | CPU Board : E-2276ME / MXM GPU : GTX1050Ti |

Block Diagram

